

30-3503-21 Information

Heisener.com

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Part Number 30-3503-21

Manufacturer Aries Electronics

Category Connectors, Interconnects

Sockets for ICs, Transistors

Description CONN IC DIP SOCKET 30POS GOLD

Package -

For the pricing/inventory/lead time, please contact

us

Website: https://www.heisener.com E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

For Reference Only

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









30-3503-21 Specifications

Manufacturer Part Number	30-3503-21
Manufacturer	Aries Electronics
Category	Connectors, Interconnects
	Sockets for ICs, Transistors
Package	-
Series	503
Type	DIP, 0.3" (7.62mm) Row Spacing
Number of Positions or Pins (Grid)	30 (2 x 15)
Pitch - Mating	0.100" (2.54mm)
Contact Finish - Mating	Gold
Contact Finish Thickness - Mating	10μin (0.25μm)
Contact Material - Mating	Beryllium Copper
Mounting Type	Through Hole
Features	Closed Frame
Termination	Wire Wrap
Pitch - Post	0.100" (2.54mm)
Contact Finish - Post	Gold
Contact Finish Thickness - Post	10μin (0.25μm)
Contact Material - Post	Phosphor Bronze
Housing Material	Polyamide (PA46), Nylon 4/6, Glass Filled
Operating Temperature	-55°C ~ 125°C
	Report errors?

30-3503-21 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

30-3503-21 Payment Methods



















30-3503-21 Shipping Methods













If you have any question about 30-3503-21, please do not hesitate to contact us!

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